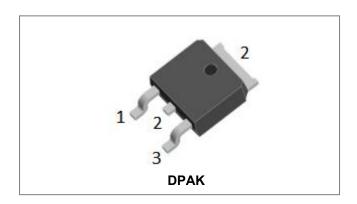


Technical Data Data Sheet N0708, Rev. A





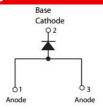
50WQ04FN SCHOTTKY RECTIFIER



Features

- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- · High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- "-A" is an AEC-Q101 qualified device
- Terminals finish: Tin Lead-free plated
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Applications

- Disk drives
- Switching power supply
- Converters
- Free-Wheeling diodes
- Reverse battery protection
- Battery charging

Maximum Ratings(at 25°C unless otherwise specified)

Characteristics	Symbol	Condition	Max.	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$egin{array}{c} V_{RRM} \ V_{RWM} \ V_{R} \end{array}$	-	40	V
Average Rectified Forward Current	I _{F (AV)}	T _C =142°C, In DC	5.5	Α
Peak One Cycle Non-Repetitive Surge Current	I _{FSM}	8.3ms, Half Sine pulse	84	Α

Electrical Characteristics:

Characteristics	Symbol	Condition	Тур.	Max.	Units
Forward Voltage Drop*	V _{F1}	 @ 5A, Pulse, T_J = 25 °C @ 10A, Pulse, T_J = 25 °C 	0.45 0.54	0.51 0.63	V
	V _{F2}	@ 5 A, Pulse, T _J = 125 °C @ 10A, Pulse, T _J = 125 °C	0.38 0.52	0.44 0.59	V
Reverse Current *	I _{R1}	@V _R = rated V _R , T _J = 25 °C	0.07	3.0	mA
	I _{R2}	@V _R = rated V _R , T _J = 125 °C	24	40	mA
Junction Capacitance	Ст	@V _R = 5V, T _C = 25 °C f _{SIG} = 1MHz	294	405	pF

^{*} Pulse width < 300 μ s, duty cycle < 2%

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Technical Data Data Sheet N0708, Rev. A





Thermal-Mechanical Specifications:

Characteristics	Symbol	Condition	Specification	Units
Junction Temperature	TJ	-	-55 to +150	°C
Storage Temperature	T _{stg}	-	-55 to +150	°C
Typical Thermal Resistance Junction to Case	R _θ JC	-	3.0	°C/W
Approximate Weight	wt	-	0.39	g
Case Style	DPAK			

Ratings and Characteristics Curves

Figure 1 Typical Forward Characteristics

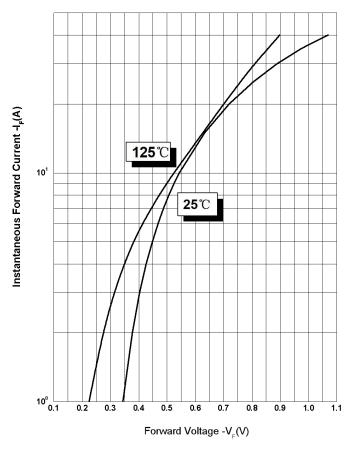


Figure 2 Typical Reverse Characteristics

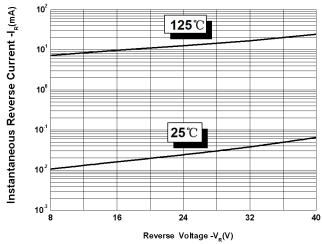
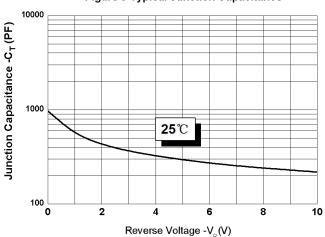


Figure 3 Typical Junction Capacitance



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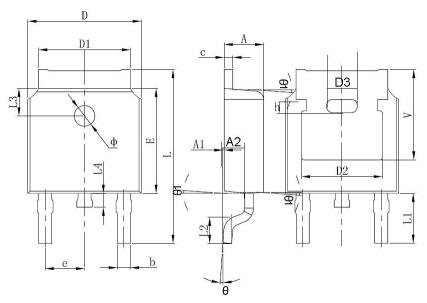


Technical Data Data Sheet N0708, Rev. A





Mechanical Dimensions DPAK



Symbol	Dimensions in millimeters		
	Min.	Typical	Max.
Α	2.18	-	2.39
A1	-	-	0.13
b	0.64	-	0.89
С	0.46	-	0.89
D	6.35	-	6.73
D1	4.95	-	5.46
D2	4.32	-	-
Е	5.97	6.1	6.22
е	2.29BSC		
L	9.4	-	10.41
L1	2.90 REF.		
L2	1.4	1.52	1.78
L3	1.60 REF.		
L4	-	-	1.02
Ф	1.1	-	1.3
Θ	0°	-	10°
V	5.21	-	-

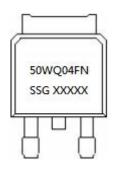
The outline from different package houses may have slight differences. So the outline above is just schematic. The dimensions are controlled per specifications.

Ordering Information

Device	Package	Shipping
50WQ04FN	DPAK (Pb-Free)	2500pcs / reel
50WQ04FNTR	DPAK (Pb-Free)	2500pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

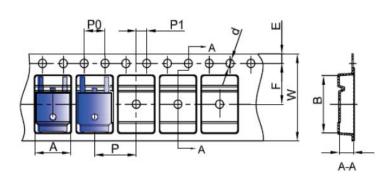


Where XXXXX is YYWWL

Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape & Reel Specification DPAK



SYMBOL	Millimeters		
STWIDGE	Min.	Max.	
Α	6.80	7.00	
В	10.40	10.60	
С	2.60	2.80	
d	Ф1.45	Ф1.65	
E	1.65	1.85	
F	7.40	7.60	
P0	3.90	4.10	
Р	7.90	8.10	
P1	1.90	2.10	
W	15.90	16.30	

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50WQ04FN



Technical Data Data Sheet N0708, Rev. A





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